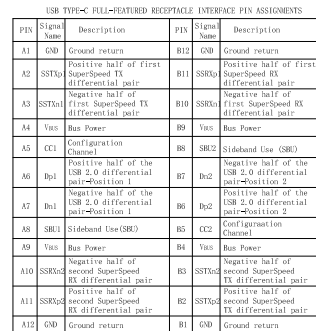
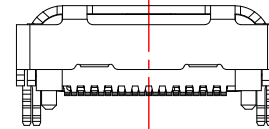




PIN	State	Description	PIN	State	Description
A1	CD	Ground return	B12	GD	Ground return
A2	STSTO	Positive half of first SuperSpeed TX differential pair	B1	STSTO	Positive half of first SuperSpeed TX differential pair
A3	STSTO	Negative half of first SuperSpeed TX differential pair	B10	STSTO	Negative half of first SuperSpeed TX differential pair
A4	Yes	Bus Power	B9	Yes	Bus Power
A5	CS1	Configuration Channel 1	B8	SRB2	Sideline Use (SRB)
A6	Bp1	Positive half of the USB 2.0 differential pair-Position 1	B7	Bx2	Positive half of the USB 2.0 differential pair-Position 2
A7	Bp1	Negative half of the USB 2.0 differential pair-Position 1	B6	Bx2	Negative half of the USB 2.0 differential pair-Position 2
A8	SRB1	Sideline Use(SRB)	B5	CC2	Configuration Channel 2
A9	Yes	Bus Power	B4	Yes	Bus Power
A10	SSRCD	Negative half of second SuperSpeed TX differential pair	B3	STSTO	Negative half of second SuperSpeed TX differential pair
A11	SSRCD	Positive half of second SuperSpeed TX differential pair	B2	STSTO	Positive half of second SuperSpeed TX differential pair
A12	GD	Ground return	B1	GD	Ground return

TOLERANCE UNLESS OTHERWISE STATED:	Up to 5	±0.2	3RD. ANGEL'S		UNITS	MM
	Above 5 ~ 15	±0.3				
	Above 15 ~ 30	±0.4				
	Above 30 ~ 50	±0.5				
	Angle	±0.3°				

MAT'L		TITLE	CONNECTOR	
FINISH		MODLE	USB 4.0 C TYPE 板上雙貼有柱 L9.87 H3.31mm 定位柱距離 7.35mm GEN 3X2 40G	
SCALE	1 : 1	DWG NO.	SBC-240S58-45x-S338	SIZE A4
SHEET NO.	1 of 1	PART NO.	SBC-240S58-45x-S338	VER R

1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall

2.Shell: Nickel under Plated surface layer